

# IGBT – Power, Co-PAK N-Channel, Field Stop VII (FS7), Non-SCR, TO247-3L 1200 V, 1.7 V, 140 A

## FGY140T120SWD

### Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 3-lead package, FGY140T120SWD offers the optimum performance with low switching and conduction losses for high-efficiency operations in various applications like Solar, UPS, and ESS.

### Features

- Maximum Junction Temperature  $T_J = 175^\circ\text{C}$
- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- Smooth and Optimized Switching
- Low Switching Loss
- RoHS Compliant

### Applications

- Boost and Inverter in Solar System
- UPS
- Energy Storage System

### MAXIMUM RATINGS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

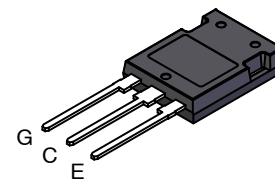
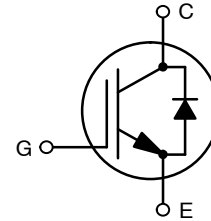
Parameter	Symbol	Value	Unit	
Collector-to-Emitter Voltage	$V_{CES}$	1200	V	
Gate-to-Emitter Voltage	$V_{GES}$	$\pm 20$		
Transient Gate-to-Emitter Voltage		$\pm 30$		
Collector Current	$I_C$	$T_C = 25^\circ\text{C}$ (Note 1)	280	A
		$T_C = 100^\circ\text{C}$	140	
Power Dissipation	$P_D$	$T_C = 25^\circ\text{C}$	1153	W
		$T_C = 100^\circ\text{C}$	576	
Pulsed Collector Current	$I_{CM}$	$T_C = 25^\circ\text{C}$ , $t_p = 10 \mu\text{s}$ (Note 2)	560	A
Diode Forward Current	$I_F$	$T_C = 25^\circ\text{C}$	280	
		$T_C = 100^\circ\text{C}$	140	
Pulsed Diode Forward Current	$I_{FM}$	$T_C = 25^\circ\text{C}$ , $t_p = 10 \mu\text{s}$ (Note 2)	560	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +175	$^\circ\text{C}$	
Lead Temperature for Soldering Purposes	$T_L$	260		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limited by bond wire
2. Repetitive rating; Pulse width limited by max. junction temperature.

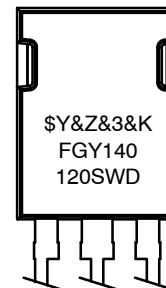
$BV_{CES}$	$V_{CE(SAT)}$	$I_C$
1200 V	1.7 V	140 A

### PIN CONNECTIONS



TO-247-3LD  
CASE 340CD

### MARKING DIAGRAM



- \$Y = onsemi Logo
- &Z = Assembly Plant Code
- &3 = 3-Digit Date Code
- &K = 2-Digit Lot Traceability Code
- FGY140120SWD = Specific Device Code

### ORDERING INFORMATION

Device	Package	Shipping
FGY140T120SWD	TO-247-3LD (Pb-Free)	30 Units / Tube

# FGY140T120SWD

## THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case for IGBT	$R_{\theta JC}$	0.13	°C/W
Thermal Resistance, Junction-to-Case for Diode		0.23	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	

## ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
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### OFF CHARACTERISTICS

Collector-to-Emitter Breakdown Voltage	$BV_{CES}$	$V_{GE} = 0\text{ V}, I_C = 5\text{ mA}$	1200	-	-	V
Breakdown Voltage Temperature Coefficient	$\frac{\Delta BV_{CES}}{\Delta T_J}$	$V_{GE} = 0\text{ V}, I_C = 5\text{ mA}$	-	1226	-	mV/°C
Collector-to-Emitter Cut-Off Current	$I_{CES}$	$V_{GE} = 0\text{ V}, V_{CE} = V_{CES}$	-	-	40	μA
Gate-to-Emitter Leakage Current	$I_{GES}$	$V_{GE} = 20\text{ V}, V_{CE} = 0\text{ V}$	-	-	±400	nA

### ON CHARACTERISTICS

Gate-to-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 140\text{ mA}, T_J = 25^\circ\text{C}$	5.60	6.54	7.40	V
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE} = 15\text{ V}, I_C = 140\text{ A}, T_J = 25^\circ\text{C}$	1.35	1.7	2.0	
		$V_{GE} = 15\text{ V}, I_C = 140\text{ A}, T_J = 175^\circ\text{C}$	-	2.25	-	

### DYNAMIC CHARACTERISTICS

Input Capacitance	$C_{ies}$	$V_{CE} = 30\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	-	13395.0	-	pF
Output Capacitance	$C_{oes}$		-	394	-	
Reverse Transfer Capacitance	$C_{res}$		-	55.4	-	
Total Gate Charge	$Q_g$	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V}, I_C = 140\text{ A}$	-	415.4	-	nC
Gate-to-Emitter Charge	$Q_{ge}$		-	104.8	-	
Gate-to-Collector Charge	$Q_{gc}$		-	154.8	-	

### SWITCHING CHARACTERISTICS

Turn-on Delay Time	$t_{d(on)}$	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V}, I_C = 70\text{ A}, R_G = 4.7\ \Omega, T_J = 25^\circ\text{C}$	-	55.2	-	ns
Turn-off Delay Time	$t_{d(off)}$		-	249.6	-	
Rise Time	$t_r$		-	43.2	-	
Fall Time	$t_f$		-	65.6	-	
Turn-on Switching Loss	$E_{on}$		-	4.7	-	
Turn-off Switching Loss	$E_{off}$	-	2.3	-		
Total Switching Loss	$E_{ts}$	-	6.9	-		
Turn-on Delay Time	$t_{d(on)}$	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V}, I_C = 140\text{ A}, R_G = 4.7\ \Omega, T_J = 25^\circ\text{C}$	-	59.2	-	ns
Turn-off Delay Time	$t_{d(off)}$		-	227.2	-	
Rise Time	$t_r$		-	97.6	-	
Fall Time	$t_f$		-	67.2	-	
Turn-on Switching Loss	$E_{on}$		-	12.5	-	
Turn-off Switching Loss	$E_{off}$	-	5.1	-		
Total Switching Loss	$E_{ts}$	-	17.6	-		

# FGY140T120SWD

## ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>SWITCHING CHARACTERISTICS</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V}$ $I_C = 70\text{ A } R_G = 4.7\ \Omega T_J = 175^\circ\text{C}$	-	48.0	-	ns
Turn-off Delay Time	$t_{d(off)}$		-	284.8	-	
Rise Time	$t_r$		-	41.6	-	
Fall Time	$t_f$		-	96.0	-	
Turn-on Switching Loss	$E_{on}$		-	7.5	-	mJ
Turn-off Switching Loss	$E_{off}$		-	3.1	-	
Total Switching Loss	$E_{ts}$		-	10.6	-	
Turn-on Delay Time	$t_{d(on)}$	$V_{CE} = 600\text{ V}, V_{GE} = 15\text{ V}$ $I_C = 140\text{ A } R_G = 4.7\ \Omega T_J = 175^\circ\text{C}$	-	52.8	-	ns
Turn-off Delay Time	$t_{d(off)}$		-	264.0	-	
Rise Time	$t_r$		-	92.8	-	
Fall Time	$t_f$		-	113.6	-	
Turn-on Switching Loss	$E_{on}$		-	17.1	-	mJ
Turn-off Switching Loss	$E_{off}$		-	7.4	-	
Total Switching Loss	$E_{ts}$		-	24.5	-	

## DIODE CHARACTERISTICS

Forward Voltage	$V_F$	$I_F = 140\text{ A}, T_J = 25^\circ\text{C}$	1.73	1.95	2.33	V
		$I_F = 140\text{ A}, T_J = 175^\circ\text{C}$	-	2.15	-	

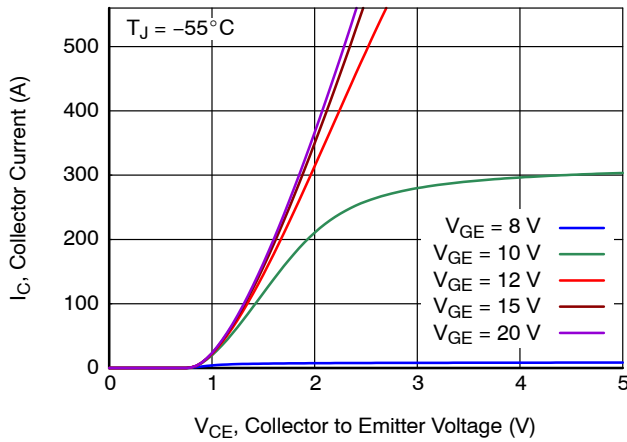
## DIODE SWITCHING CHARACTERISTICS, INDUCTIVE LOAD

Reverse Recovery Time	$t_{rr}$	$V_R = 600\text{ V}, I_F = 70\text{ A},$ $di_F/dt = 1000\text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$	-	219.4	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	4507.9	-	nC
Reverse Recovery Energy	$E_{REC}$		-	1.6	-	mJ
Peak Reverse Recovery Current	$I_{RRM}$		-	41.1	-	A
Reverse Recovery Time	$t_{rr}$	$V_R = 600\text{ V}, I_F = 140\text{ A},$ $di_F/dt = 1000\text{ A}/\mu\text{s}, T_J = 25^\circ\text{C}$	-	307.3	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	7047.2	-	nC
Reverse Recovery Energy	$E_{REC}$		-	2.7	-	mJ
Peak Reverse Recovery Current	$I_{RRM}$		-	45.9	-	A
Reverse Recovery Time	$t_{rr}$	$V_R = 600\text{ V}, I_F = 70\text{ A},$ $di_F/dt = 1000\text{ A}/\mu\text{s}, T_J = 175^\circ\text{C}$	-	425.3	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	13076.8	-	nC
Reverse Recovery Energy	$E_{REC}$		-	5.5	-	mJ
Peak Reverse Recovery Current	$I_{RRM}$		-	61.5	-	A
Reverse Recovery Time	$t_{rr}$	$V_R = 600\text{ V}, I_F = 140\text{ A},$ $di_F/dt = 1000\text{ A}/\mu\text{s}, T_J = 175^\circ\text{C}$	-	516.5	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	18736.9	-	nC
Reverse Recovery Energy	$E_{REC}$		-	7.6	-	mJ
Peak Reverse Recovery Current	$I_{RRM}$		-	72.6	-	A

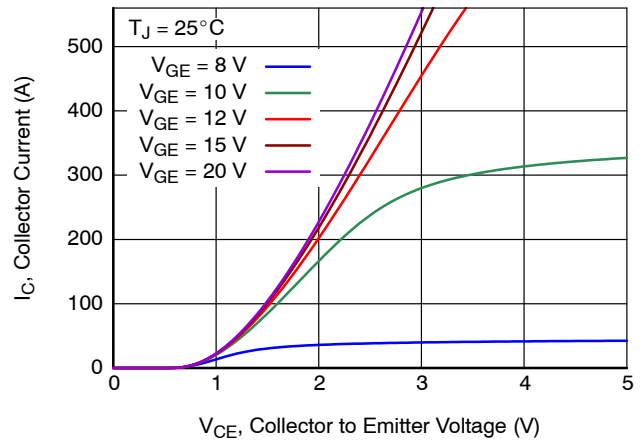
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# FGY140T120SWD

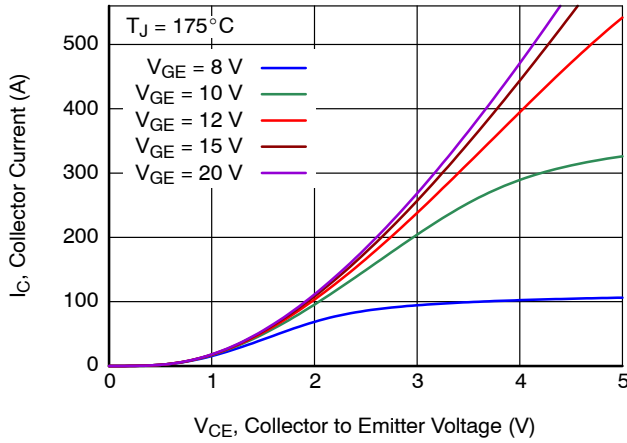
## TYPICAL CHARACTERISTICS



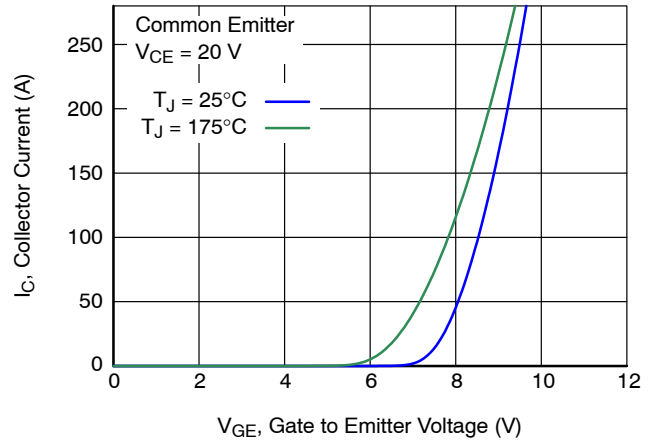
**Figure 1. Output Characteristics**



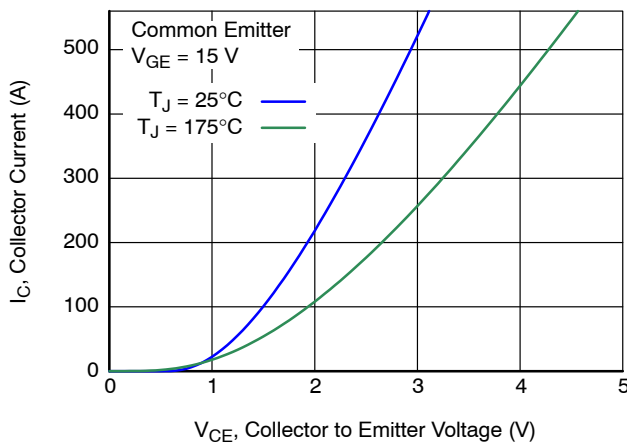
**Figure 2. Output Characteristics**



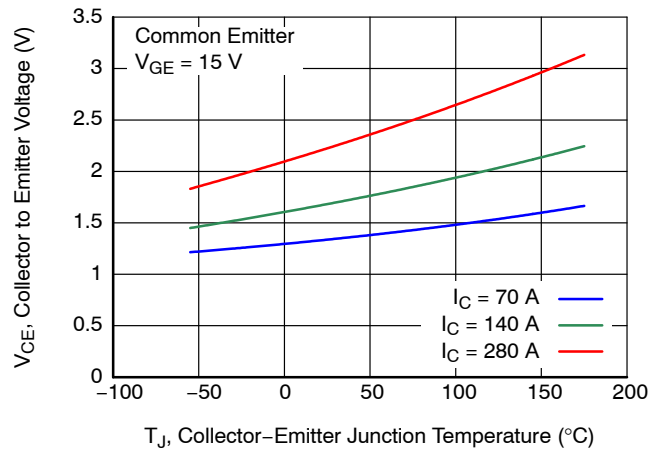
**Figure 3. Output Characteristics**



**Figure 4. Transfer Characteristics**



**Figure 5. Saturation Characteristics**



**Figure 6. Saturation Voltage vs. Junction Temperature**

# FGY140T120SWD

## TYPICAL CHARACTERISTICS

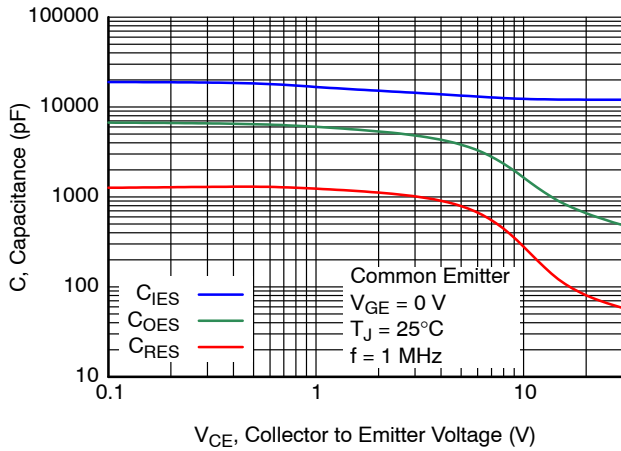


Figure 7. Capacitance Characteristics

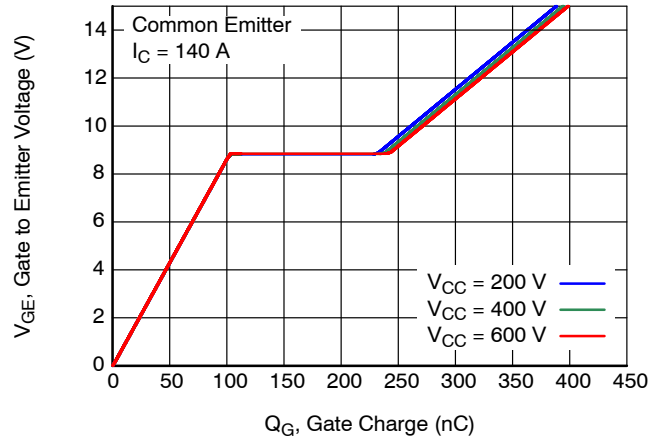


Figure 8. Gate Charge Characteristics

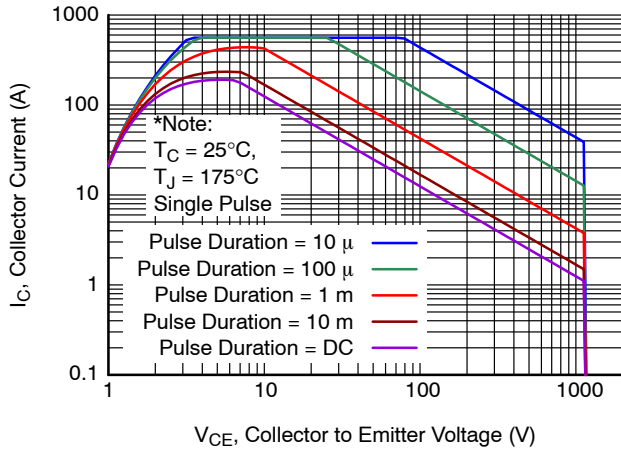


Figure 9. SOA Characteristics

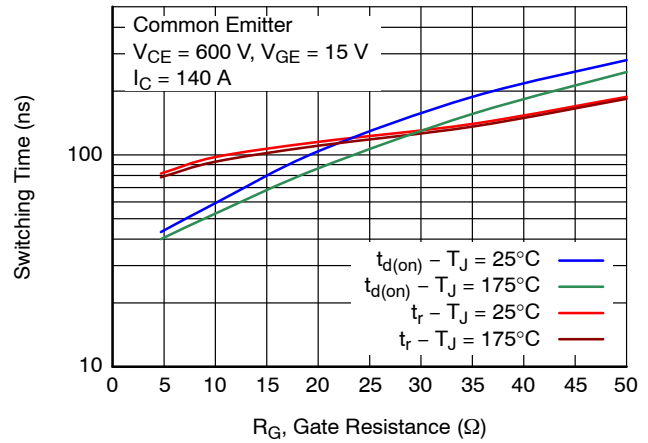


Figure 10. Turn-on Switching Time vs. Gate Resistance

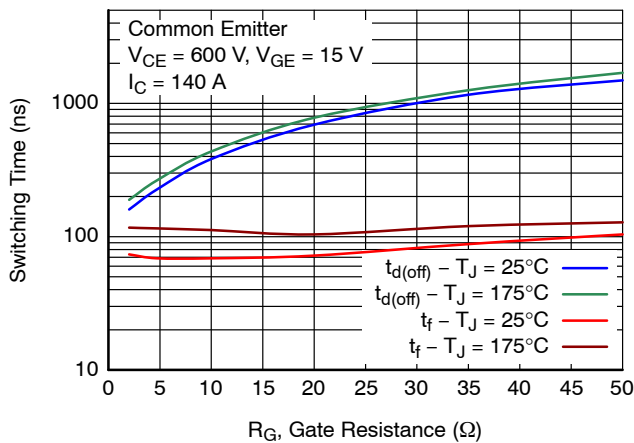


Figure 11. Turn-Off Switching Time vs. Gate Resistance

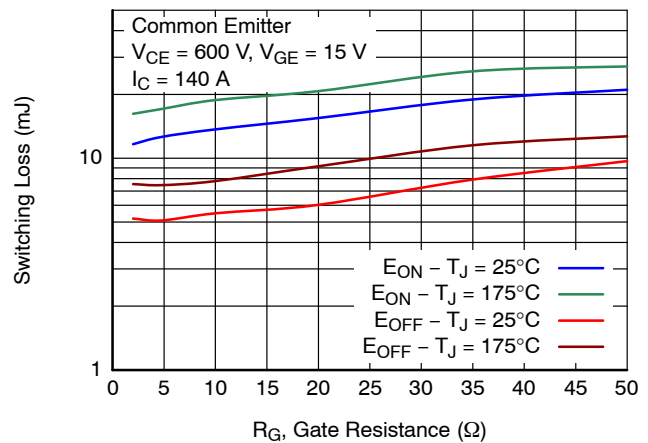
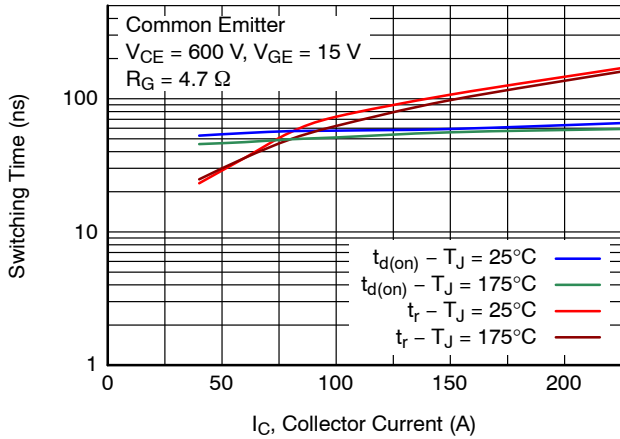


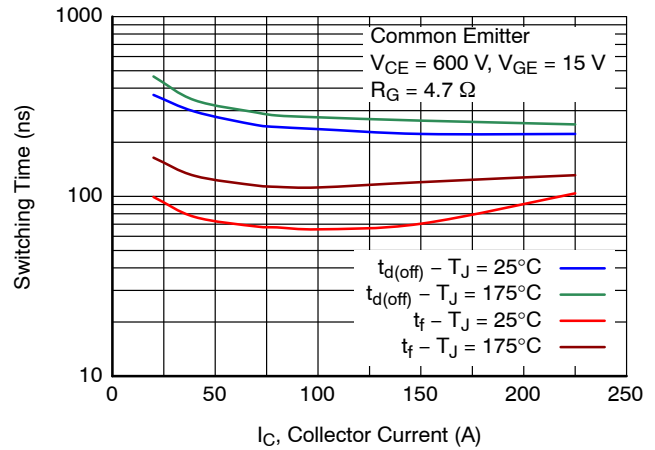
Figure 12. Switching Loss vs. Gate Resistance

# FGY140T120SWD

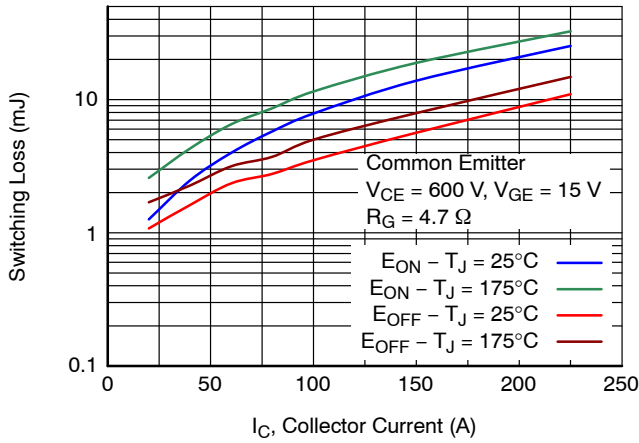
## TYPICAL CHARACTERISTICS



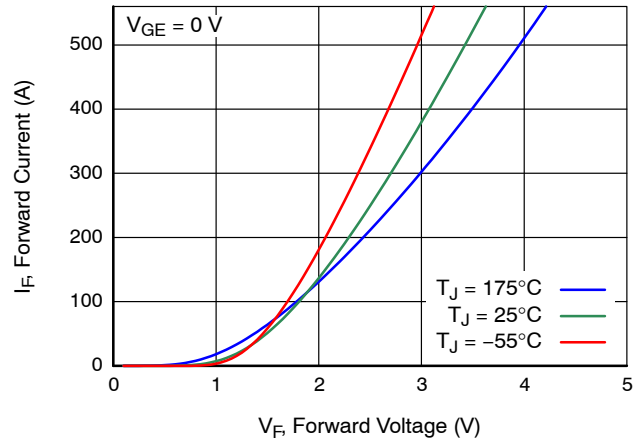
**Figure 13. Turn-On Switching Time vs. Collector Current**



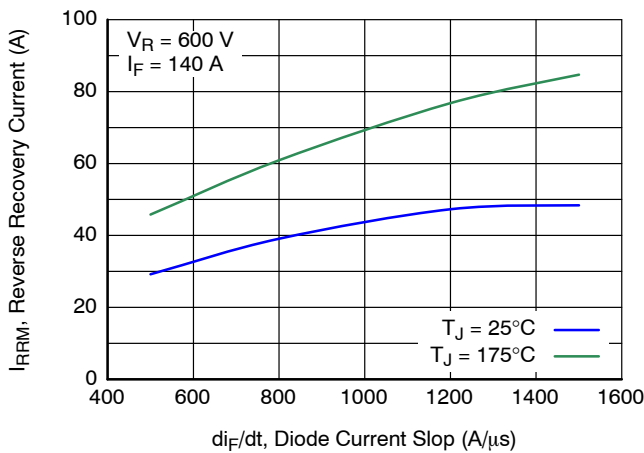
**Figure 14. Turn-Off Switching Time vs. Collector Current**



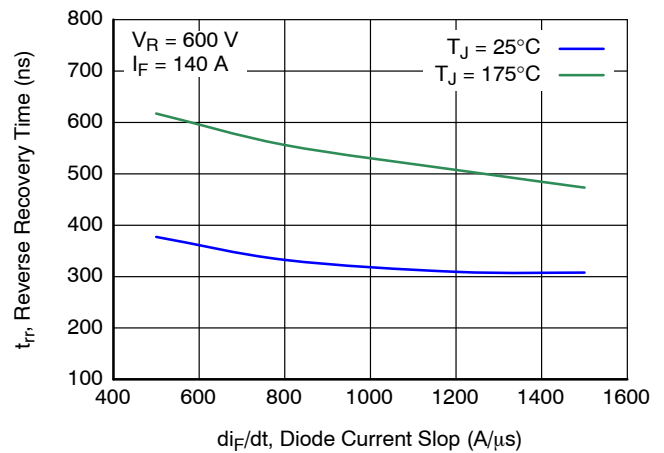
**Figure 15. Turn-On Switching Loss vs. Collector Current**



**Figure 16. Diode Forward Characteristics**



**Figure 17. Diode Reverse Recovery Current**



**Figure 18. Diode Reverse Recovery Time**

# FGY140T120SWD

## TYPICAL CHARACTERISTICS

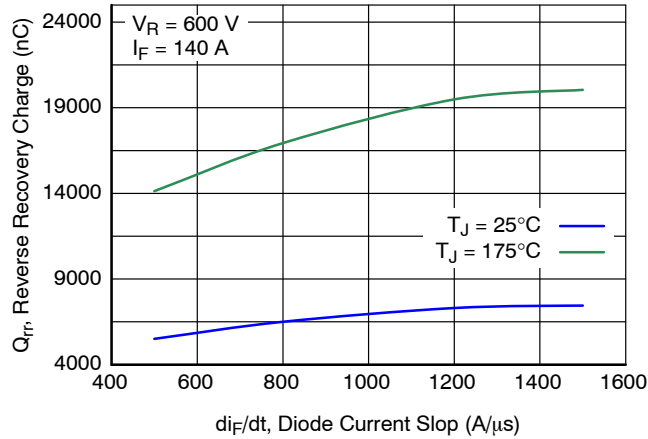


Figure 19. Diode Stored Charge Characteristics

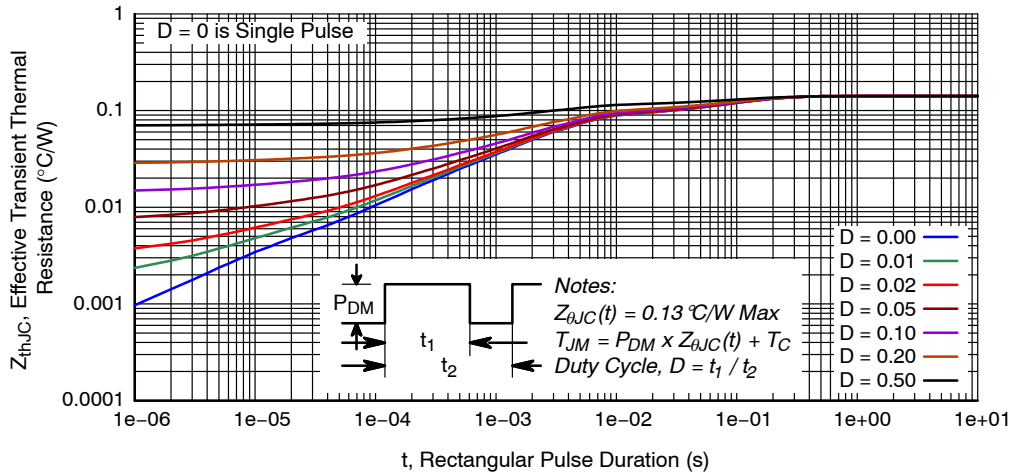


Figure 20. Transient Thermal Impedance of IGBT

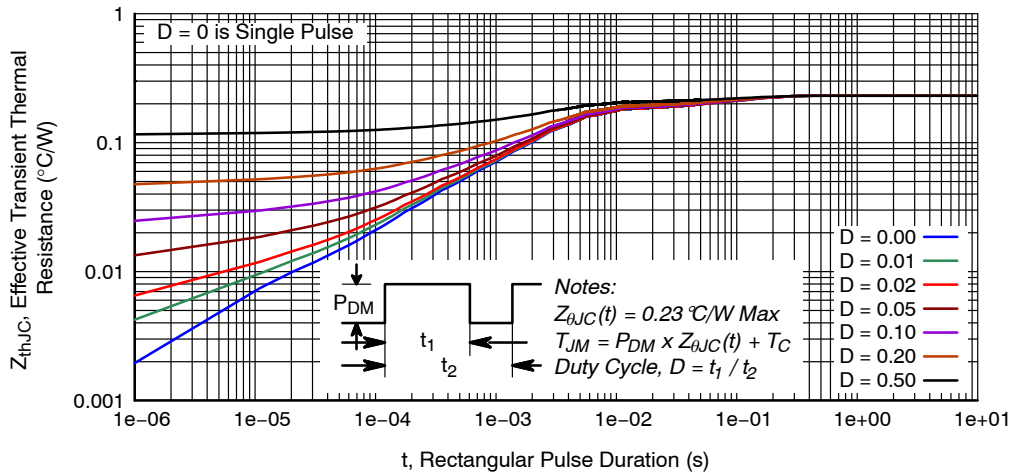


Figure 21. Transient Thermal Impedance of Diode

# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

ON Semiconductor®



TO-247-3LD  
CASE 340CD  
ISSUE A

DATE 18 SEP 2018

**NOTES:**

- A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.80	2.00	2.20
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.12	4.32	4.52
e	~	5.45	~
L	19.90	20.00	20.10
L1	3.69	3.81	3.93
Q	5.34	5.46	5.58
b	1.10	1.20	1.30
b2	2.10	2.24	2.39
b4	2.87	3.04	3.20
c	0.51	0.61	0.71
D1	16.63	16.83	17.03
D2	0.51	0.93	1.35
E1	13.40	13.60	13.80

**GENERIC MARKING DIAGRAM\***



- XXXX = Specific Device Code
- A = Assembly Location
- Y = Year
- WW = Work Week
- G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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